

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application: : Group Art Unit: 1733
M. Gaynes et al : Examiner: J. Haran
Serial No.: 10/085,313 : IBM Corporation
Filed: 02/28/2002 : Intellectual Property Law
Title: METHOD FOR BONDING HEAT : Department 1Q0A/040-3
SINKS TO OVERMOLD MATERIAL : 1701 North Street
: Endicott, NY 13760

Assistant Commissioner For Patents
Washington, DC 20231

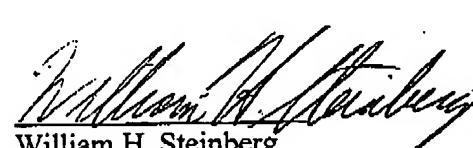
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Telephone: (607) 429-3979
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William H. Steinberg
Reg. No: 28,540

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(37 CFR 1.8(a))

Docket No.
END920010053US1

In Re Application Of: M. Gaynes et al

Serial No.
10/085,313

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Examiner
J. Haran

Group Art Unit
1733

Invention: METHOD FOR BONDING HEAT SINKS TO OVERMOLD MATERIAL

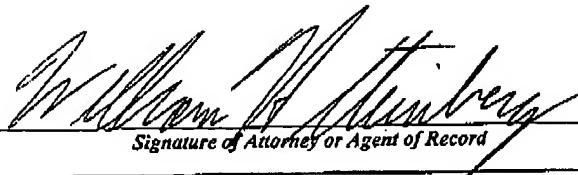
TO THE COMMISSIONER FOR PATENTS

Please send all correspondence for this application to:

William H. Steinberg
IBM Corporation Dept. IQ0A/Bldg. 40-3
1701 North Street
Endicott, NY 13760

Please direct all telephone calls to:

William H. Steinberg (607) 429-3979


Signature of Attorney or Agent of Record

William H. Steinberg Reg. No: 28,540
IBM Corporation Dept. IQ0A/Bldg. 40-3
1701 North Street
Endicott, NY 13760

Registration Number & Address of Attorney or Agent of Record

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